PME271E, Metallized Impregnated Paper, Class X1, 300 VAC



Overview Applications

Multilayer metallized paper encapsulated and impregnated in self-extinguishing material, meeting the requirements of UL 94 V=0.

For worldwide use as an electromagnetic interference suppressor in all X1 and across-the-line applications.

Benefits

· Approvals: ENEC, UL

Rated voltage: 300 VAC 50/60 Hz
 Capacitance range: 0.01μF – 0.22 μF

Lead Spacing: 15.2 – 25.4 mm

 Capacitance tolerance: ±20% for C ≤ 0.1μF, ±10% for C > 0.1 μF

Climatic category: 40/110/56/B, IEC 60068-1

• Tape & Reel packaging in accordance with IEC 60286-2

RoHS compliance and lead-free terminations

• Operating temperature range of -40°C to +110°C

• 100% screening factory test at 2,150 VDC

Highest possible safety regarding active and passive flammability



Customer Part Number

| PME271 | Е | (D) | 510(0) | M | R30 |
|----------------------|---------------------|------------------------------|--|---|-------------------------------|
| Series | Rated Voltage (VAC) | Lead Spacing (mm) | Capacitance Code (pF) | Capacitance Tolerance | Packaging |
| X1, Metallized Paper | E = 300 | Blank = Standard D = 22.5 | The last three digits represent significant figures. The first digit specifies the total number of digits. | M = $\pm 20\%$ (for C \leq 0.1 μ F) K = $\pm 10\%$ (for C > 0.1 μ F) | See Ordering Options Table |

KEMET Internal Part Number

| Р | 277 | Q | E | 103 | M | 300 | A |
|-----------------|-------------------------|--|------------------------|--|---|------------------------|-------------------------------|
| Capacitor Class | Series | Lead Spacing (mm) | Size Code | Capacitance Code (pF) | Capacitance Tolerance | Rated Voltage (VAC) | Packaging |
| P = Paper | X1, Metallized Paper | Q = 15.2 C = 20.3 S = 22.5 E = 25.4 | See Dimension Table | First two digits represent significant figures. Third digit specifies number of zeros. | M = $\pm 20\%$ (for C \leq 0.1 μ F) K = $\pm 10\%$ (for C > 0.1 μ F) | 300 = 300 | See Ordering Options Table |

Built Into Tomorrow



Benefits cont.

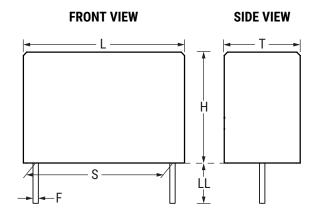
- Excellent self-healing properties which ensure long life even when subjected to frequent overvoltages
- Good resistance to ionization due to impregnated paper dielectric
- · High dv/dt capability
- Impregnated paper ensures excellent stability and reliability properties, particularly in applications with continuous operation

Ordering Options Table

| Lead Spacing Nominal (mm) | Type of Leads and Packaging | Lead Length (mm) | KEMET Lead and Packaging Code | Legacy Lead and Packaging Code |
|------------------------------------|---|----------------------------|--|---|
| | Standard Lead and Packaging Options | | | |
| | Bulk (Bag) – Short Leads | 6 +0/-1 | С | R06 |
| 15.0 | Bulk (Bag) – Maximum Length Leads | 30 +5/-0 | Α | R30 |
| 15.2 | Tape & Reel (Standard Reel) | $H_0 = 18.5 \pm 0.5$ | L | R19T0 |
| | Other Lead and Packaging Options | | | |
| | Tape & Reel (Large Reel) | $H_0 = 18.5 \pm 0.5$ | Р | R19T1 |
| | | | | |
| | Standard Lead and Packaging Options | | | |
| | Bulk (Tray) – Short Leads | 6 +0/-1 | С | R06 |
| 20.3 | Bulk (Bag) – Maximum Length Leads | 30 +5/-0 | Α | R30 |
| 20.0 | Tape & Reel (Standard Reel) | $H_0 = 18.5 \pm 0.5$ | L | R19T0 |
| | Other Lead and Packaging Options | | | |
| | Tape & Reel (Large Reel) | $H_0 = 18.5 \pm 0.5$ | Р | R19T1 |
| | Standard Lead and Packaging Options | | | |
| | 0 0 1 | 6 +0/-1 | С | R06 |
| | Bulk (Tray) – Short Leads Bulk (Bag) – Maximum Length Leads | 30 +5/-0 | A | R30 |
| 22.5 | Tape & Reel (Standard Reel) | H ₀ = 18.5 ±0.5 | L | R19T0 |
| | Other Lead and Packaging Options | 110-10.0 10.0 | _ | KIJIO |
| | Tape & Reel (Large Reel) | H _o = 18.5 ±0.5 | P | R19T1 |
| | Tape & Neel (Large Neel) | 110-10.0 ±0.0 | Г | 1/1711 |
| | Standard Lead and Packaging Options | | | |
| 25.4 | Bulk (Tray) – Short Leads | 6 +0/-1 | С | R06 |
| | Bulk (Bag) – Maximum Length Leads | 30 +5/-0 | Α | R30 |



Dimensions - Millimeters



| Ciro Codo | | S | Т | | Н | | L | | F | |
|-----------|---------|-----------|----------------|----------------|---------------|-----------------|---------|-----------|---------|-----------|
| Size Code | Nominal | Tolerance | Nominal | Tolerance | Nominal | Tolerance | Nominal | Tolerance | Nominal | Tolerance |
| QE | 15.2 | ±0.4 | 5.2 | Maximum | 10.5 | Maximum | 18.5 | Maximum | 0.8 | ±0.05 |
| QN | 15.2 | ±0.4 | 7.3 | Maximum | 13.0 | Maximum | 19.0 | Maximum | 0.8 | ±0.05 |
| QS | 15.2 | ±0.4 | 8.5 | Maximum | 14.3 | Maximum | 18.5 | Maximum | 0.8 | ±0.05 |
| CE | 20.3 | ±0.4 | 7.6 | Maximum | 14.0 | Maximum | 24.0 | Maximum | 0.8 | ±0.05 |
| СР | 20.3 | ±0.4 | 11.3 | Maximum | 16.5 | Maximum | 24.0 | Maximum | 0.8 | ±0.05 |
| SJ | 22.5 | ±0.4 | 8.0 | Maximum | 17.0 | Maximum | 27.0 | Maximum | 0.8 | ±0.05 |
| SP | 22.5 | ±0.4 | 10.0 | Maximum | 19.0 | Maximum | 27.0 | Maximum | 0.8 | ±0.05 |
| SU | 22.5 | ±0.4 | 12.0 | Maximum | 22.0 | Maximum | 27.0 | Maximum | 0.8 | ±0.05 |
| EE | 25.4 | ±0.4 | 10.6 | Maximum | 16.1 | Maximum | 30.5 | Maximum | 1.0 | ±0.05 |
| EJ | 25.4 | ±0.4 | 12.1 | Maximum | 19.0 | Maximum | 30.5 | Maximum | 1.0 | ±0.05 |
| | | No | te: See the Or | dering Options | Table for lea | d lenath (LL) o | ntions. | | | |



Performance Characteristics

| 300 VAC 50/60 Hz | | | | |
|---|---|--|--|--|
| | | | | |
| 0.01 - 0.22 μF | | | | |
| ±20% for C ≤ 0.1 µF, ±10% for C > 0 |).1 μF | | | |
| -40°C to +110°C | | | | |
| 40/110/56/B | | | | |
| ENEC, UL | | | | |
| Maximum Values at +23°C | | | | |
| 1 kHz 1.3% | | | | |
| The 100% screening factory test in the 100% screening factory test in the test is selected to meet the test in the test. It is not permitted the test. It is not permitted the test is to damage the capacitor. KEN any failures. | he requirements in applicable al characteristics are checked | | | |
| Minimum Values B | etween Terminals | | | |
| C ≤ 0.33 µF | ≥ 12,000 MΩ | | | |
| C > 0.33 μF | ≥ 4,000 MΩ • µF | | | |
| Recommended voltage ≤ 630 VDC | | | | |
| 1 | 20% for C \leq 0.1 μF, \pm 10% for C $>$ 0.40°C to \pm 110°C 0/110/56/B NEC, UL Maximum Val 1 kHz The 100% screening factory test i oltage level is selected to meet t quipment standards. All electric fter the test. It is not permitted t isk to damage the capacitor. KEM ny failures. Minimum Values B C \leq 0.33 μF C $>$ 0.33 μF | | | |

Environmental Test Data

| Test | IEC Publication | Procedure |
|------------------------|-------------------------|---|
| Endurance | IEC 60384-14 | 1.25 x V _R VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature |
| Vibration | IEC 60068-2-6 Test Fc | 3 directions at 2 hours each 10 – 55 Hz at 0.75 mm or 98 m/s ² |
| Bump | IEC 60068-2-29 Test Eb | 1,000 bumps at 390 m/s ² |
| Change of Temperature | IEC 60068-2-14 Test Na | Upper and lower rated temperature 5 cycles |
| Active Flammability | IEC 60384-14 | V _R +20 surge pulses at 2.5 kV (pulse every 5 seconds) |
| Passive Flammability | IEC 60384-14 | IEC 60384-1, IEC 60695-11-5 Needle-flame test |
| Damp Heat Steady State | IEC 60068-2-78 Test Cab | +40°C and 93% RH, 56 days |



Approvals

| Certification Body | Mark | Specification | File Number |
|--------------------|------------------|----------------------------------|-------------|
| Intertek Semko AB | | EN/IEC 60384-14 | SE/0140-15D |
| UL | c FL ® us | UL 60384-14 CAN/CSA-E60384-14 | E73869 |

Environmental Compliance

All KEMET EMI capacitors are RoHS compliant.



Table 1 - Ratings & Part Number Reference

| Capacitance | Maximun | Maximum Dimensions in mm | | | f | dV/dt | KEMET | Customer |
|---------------------------|---------|--------------------------|--------|---------------------|----------------------|-----------------|----------------------|-------------------------|
| Value (µF) | Т | Н | L | Spacing (S) | (MHz) | (V/µs) | Part Number | Part Number |
| 0.010 | 5.2 | 10.5 | 18.5 | 15.2 | 16 | 1,200 | P277QE103M300(1) | PME271E510M(1) |
| 0.015 | 5.2 | 10.5 | 18.5 | 15.2 | 13 | 1,200 | P277QE153M300(1) | PME271E515M(1) |
| 0.022 | 7.3 | 13 | 18.5 | 15.2 | 9.8 | 1,200 | P277QN223M300(1) | PME271E522M(1) |
| 0.033 | 7.3 | 13 | 18.5 | 15.2 | 7 | 1,200 | P277QN333M300(1) | PME271E533M(1) |
| 0.047 | 8.5 | 14.3 | 18.5 | 15.2 | 6.4 | 1,200 | P277QS473M300(1) | PME271E547M(1) |
| 0.068 | 7.6 | 14 | 24 | 20.3 | 5.2 | 600 | P277CE683M300(1) | PME271E568M(1) |
| 0.1 | 11.3 | 16.5 | 24 | 20.3 | 4.1 | 600 | P277CP104M300(1) | PME271E610M(1) |
| 0.068 | 8 | 17 | 27 | 22.5 | 4.7 | 600 | P277SJ683M300(1) | PME271ED5680M(1) |
| 0.1 | 8 | 17 | 27 | 22.5 | 4.1 | 600 | P277SJ104M300(1) | PME271ED6100M(1) |
| 0.15 | 10 | 19 | 27 | 22.5 | 3.2 | 600 | P277SP154K300(1) | PME271ED6150K(1) |
| 0.22 | 12 | 22 | 27 | 22.5 | 2.5 | 600 | P277SU224K300(1) | PME271ED6220K(1) |
| 0.15 | 10.6 | 16.1 | 30.5 | 25.4 | 3.3 | 400 | P277EE154K300(1) | PME271E615K(1) |
| 0.22 | 12.1 | 19 | 30.5 | 25.4 | 2.6 | 400 | P277EJ224K300(1) | PME271E622K(1) |
| Capacitance Value (µF) | T (mm) | H (mm) | L (mm) | Lead Spacing (S) | f _。 (MHz) | dV/dt (V/μs) | KEMET Part Number | Customer Part Number |

⁽¹⁾ Insert lead and packaging code. See Ordering Options Table for available options.



Soldering Process

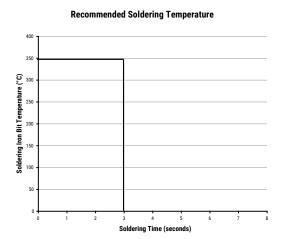
The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183° C for SnPb eutectic alloy to $217 - 221^{\circ}$ C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is $160 - 170^{\circ}$ C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 - 15 mm), and great care must be taken during soldering. The recommended solder profiles from KEMET should be used. Consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. See Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the recommended limits may result in degradation of or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface-mount components. Insert through-hole parts after curing the surface-mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum of two soldering cycles is recommended. Allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

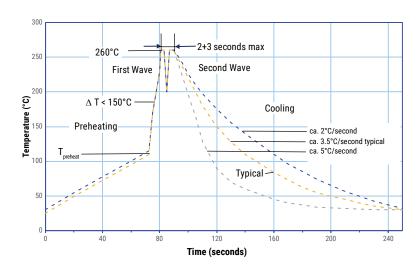
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



Soldering iron tip temperature should be set at 350°C (+10°C maximum), with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont.

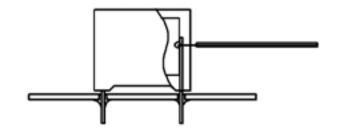
Wave Soldering Recommendations cont.

1. The table indicates the maximum setup temperature for the soldering process.

| Dielectric film | Maximun Tempe | n Preheat erature | Maximum Peak Soldering Temperature | | | |
|---------------------------|----------------------------|----------------------------|---------------------------------------|----------------------------|--|--|
| material | Capacitor Pitch ≥ 10 mm | Capacitor Pitch > 15 mm | Capacitor Pitch ≤ 15 mm | Capacitor Pitch > 15 mm | | |
| Polyester | 130°C | 130°C | 270°C | 270°C | | |
| Polypropylene | 110°C | 130°C | 260°C | 270°C | | |
| Paper | 130°C | 140°C | 270°C | 270°C | | |
| Polyphenylene Sulphide | 150°C | 160°C | 270°C | 270°C | | |

2. The maximum temperature measured inside the capacitor: set the temperature so that inside the element the maximum temperature is below the limit.

| Dielectric Film Material | Maximum Temperature Measured Inside the Element |
|--------------------------|--|
| Polyester | 160°C |
| Polypropylene | 110°C |
| Paper | 160°C |
| Polyphenylene Sulphide | 160°C |



Temperature monitored inside the capacitor.

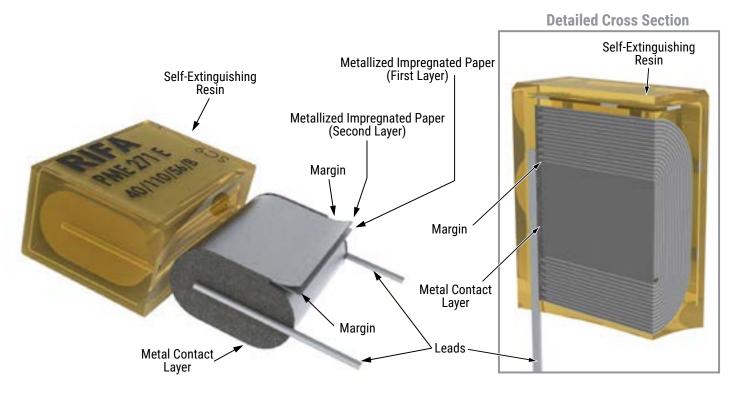
Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath, as in normal flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder, only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

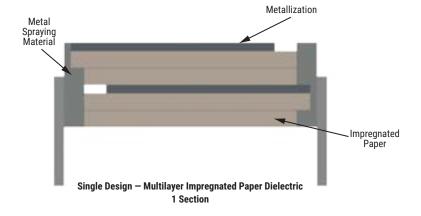
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document. **However, instead of two baths, there is only one with a time from 3 to 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering. Great care must be taken so that the parts do not overheat.



Construction

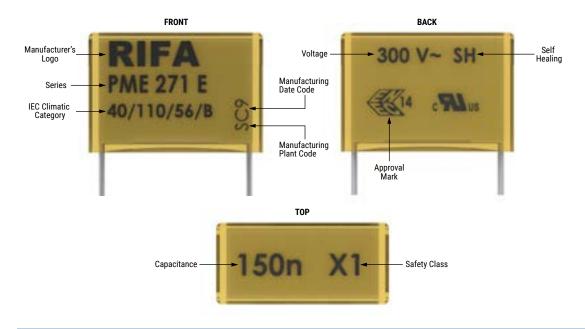


Winding Scheme





Marking



Packaging Quantities

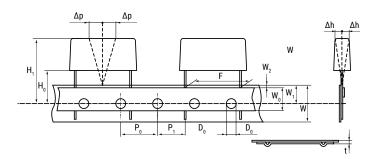
| Lead Spacing (mm) | Thickness (mm) | Height (mm) | Length (mm) | Bulk Short Leads | Bulk Long Leads | Standard Reel 360 mm | Large Reel 500 mm |
|-------------------|----------------|-------------|----------------|---------------------|--------------------|-------------------------|----------------------|
| | 5.5 | 12.5 | 18.0 | 1,000 | 500 | 600 | |
| | 6.5 | 12.5 | 18.0 | 600 | 400 | 400 | |
| | 7.5 | 14.5 | 18.0 | 600 | 400 | 400 | |
| | 8.5 | 16.0 | 18.0 | 400 | 250 | 400 | |
| 15.2 | 5.2 | 10.5 | 18.5 | 1,000 | 500 | 600 | |
| 15.2 | 5.5 | 11.1 | 18.5 | 1,000 | 500 | 500 | |
| | 6.0 | 12.5 | 18.5 | 600 | 400 | 400 | |
| | 7.3 | 13.0 | 18.5 | 600 | 400 | 400 | 800 |
| | 7.8 | 13.5 | 18.5 | 600 | 400 | 400 | |
| | 8.5 | 14.3 | 18.5 | 500 | 300 | 350 | |
| | | 110 | 21.2 | 1.500 | | 250 | |
| | 7.6 | 14.0 | 24.0 | 1,500 | 250 | 250 | 500 |
| 20.3 | 8.4 | 14.0 | 24.0 | 1,200 | 200 | 250 | 500 |
| 20.5 | 9.0 | 15.0 | 24.0 | 1,500 | 200 | 250 | |
| | 11.3 | 16.5 | 24.0 | 1,000 | 150 | 180 | 400 |
| | 8.0 | 17.0 | 27.0 | 1,200 | 200 | | |
| 22.5 | 10.0 | 19.0 | | | 150 | 200 | |
| 22.5 | | - | 27.0 | 1,000 | | | 050 |
| | 12.0 | 22.0 | 27.0 | 800 | 100 | 180 | 350 |
| | 10.6 | 16.1 | 30.5 | 1,000 | 150 | | |
| | 10.5 | 17.3 | 30.5 | 1,000 | 100 | | |
| 25.4 | 12.1 | 19.0 | 30.5 | 800 | 100 | | |
| | 15.3 | 22.0 | 30.5 | 600 | 75 | | |



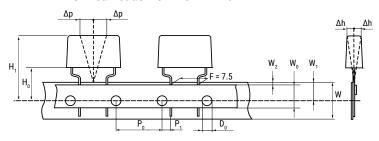
Lead Taping & Packaging (IEC 60286-2)

Lead Spacing 10.2 - 15.2 mm

Lead Spacing 20.3 - 22.5 mm



Formed Leads from 10.2 - 7.5 mm



Taping Specification

| | Standard IEC 60286-2 | | | | | | | |
|-------------------------------|-------------------------|-------------------------------|------------|----------|----------|----------|-------------|----------------|
| Lead Spacing | +0.6/-0.1 | F | Formed 7.5 | 10.2 | 15.2 | 20.3 | 22.5 | F |
| Carrier Tape Width | ±0.5 | W | 18.0 | 18.0 | 18.0 | 18.0 | 18.0 | 18 +1/-0.5 |
| Hold-Down Tape Width | Minimum | W_{0} | 5.0 | 5.0 | 5.0 | 5.0 | 5.0 | |
| Position of Sprocket Hole | ±0.5 | W ₁ | 9.0 | 9.0 | 9.0 | 9.0 | 9.0 | 9 +0.75/-0.5 |
| Distance Between Tapes | Maximum | W_2 | 3.0 | 3.0 | 3.0 | 3.0 | 3.0 | 3.0 |
| Sprocket Hole Diameter | ±0.2 | D ₀ | 4.0 | 4.0 | 4.0 | 4.0 | 4.0 | 4.0 |
| Feed Hole Lead Spacing | ±0.3 | P ₀ ⁽¹⁾ | 12.7(4) | 12.7 | 12.7 | 12.7 | 12.7 | 12.7 |
| Distance Lead - Feed Hole | ±0.7 | P ₁ | 3.75 | 7.6 | 5.1 | 8.9 | 5.3 | P ¹ |
| Deviation Tape - Plane | Maximum | Δр | 1.3 | 1.3 | 1.3 | 1.3 | 1.3 | 1.3 |
| Lateral Deviation | Maximum | Δh | 2.0 | 2.0 | 2.0 | 2.0 | 2.0 | 2.0 |
| Total Thickness | ±0.2 | t | 0.7 | 0.7 | 0.7 | 0.7 | 0.9 Maximum | 0.9 Maximum |
| Sprocket Hole/Cap Body | Nominal | H ₀ ⁽²⁾ | 18 +2/-0 | 18 +2/-0 | 18 +2/-0 | 18 +2/-0 | 18.5 ±0.5 | 18 +2/-0 |
| Sprocket Hole/Top of Cap Body | Maximum | H ₁ ⁽³⁾ | 43 | 43 | 43 | 58 | 58 | 58 Maximum |

⁽¹⁾ Maximum cumulative feed hole error, 1 mm per 20 parts

^{(2) 16.5} mm available on request

⁽³⁾ Depending on case size

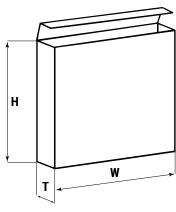
^{(4) 15} mm available on request



Lead Taping & Packaging (IEC 60286-2) cont.

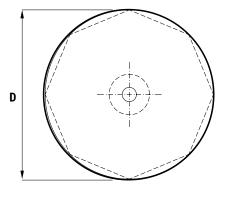
Ammo Specifications

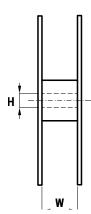
| Series | Dimensions (mm) | | |
|------------------------|-----------------|-----|----|
| Series | Н | W | T |
| R4x, R4x+R, R7x, RSB | | | |
| F5A, F5B, F5D | 360 | 340 | 59 |
| F6xx, F8xx | | | |
| PHExxx, PMExxx, PMRxxx | 330 | 330 | 50 |



Reel Specifications

| Carias | Dimensions (mm) | | |
|------------------------|-----------------|----------|----------|
| Series | D | Н | W |
| R4x, R4x+R, R7x, RSB | 055 | | |
| F5A, F5B, F5D | 355 500 | 30 25 | 55 (Max) |
| F6xx, F8xx | 300 | 25 | |
| PHExxx, PMExxx, PMRxxx | 360 500 | 30 | 46 (Max) |





Manufacturing Date Code (IEC-60062)

| Y = Year, Z = Month | | | | | |
|---------------------|------|-----------|------|--|--|
| Year | Code | Month | Code | | |
| 2010 | Α | January | 1 | | |
| 2011 | В | February | 2 | | |
| 2012 | С | March | 3 | | |
| 2013 | D | April | 4 | | |
| 2014 | E | May | 5 | | |
| 2015 | F | June | 6 | | |
| 2016 | Н | July | 7 | | |
| 2017 | J | August | 8 | | |
| 2018 | K | September | 9 | | |
| 2019 | L | October | 0 | | |
| 2020 | M | November | N | | |
| 2021 | N | December | D | | |
| 2022 | Р | | | | |
| 2023 | R | | | | |
| 2024 | S | | | | |
| 2025 | Т | | | | |
| 2026 | U | | | | |
| 2027 | V | | | | |
| 2028 | W | | | | |
| 2029 | X | | | | |
| 2030 | Α | | | | |



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46KN3330JBM1K 413N32200000M 463I333000M1K 46KF2470JBN0M 46KF268000M1M 46KF310000M1M 46KI22205001M

46KI24705201K 46KI2470CK01M 46KI2470ND01K 46KI2680JH01M 46KI315000M2K 46KI315000M2M 46KI3150CKM2K

46KI3150CKM2M 46KI3150NDM2M 46KI3220CKP0M 46KI3220JLM1M 46KN3150JH01K 46KN34705001K 46KN347050N0K

46KN3470JHP0M 46KN410040H1M 46KW510050M1K 474I24700003K PHE840MD6220MD13R30 PHE840MY6470MD14R06

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YP501101K040BAND5P YP102681K060B20C6P YP501121K040B20C6P YP501471K040B20C6P